

DATA SHEET

TDA1519

**2 x 6 W stereo car radio power
amplifier**

Product specification
File under Integrated Circuits, IC01

May 1992

2 x 6 W stereo car radio power amplifier**TDA1519****GENERAL DESCRIPTION**

The TDA1519 is an integrated class-B dual output amplifier in a 9-lead single in-line (SIL) plastic medium power package. The device is primarily developed for car radio applications.

Features

- Requires very few external components
- High output power
- Fixed gain
- Good ripple rejection
- Mute/stand-by switch
- Load dump protection
- AC and DC short-circuit-safe to ground and V_P
- Thermally protected
- Reverse polarity safe
- Capability to handle high energy on outputs ($V_P = 0$ V)
- No switch-on/switch-off pop
- Protected against electrostatic discharge
- Compatible with TDA1517 (except gain).

QUICK REFERENCE DATA

PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage range						
operating		V_P	6,0	14,4	18,0	V
non-operating		V_P	—	—	30	V
load dump protected		V_P	—	—	45	V
Repetitive peak output current		I_{ORM}	—	—	2,5	A
Total quiescent current		I_{tot}	—	40	80	mA
Stand-by current		I_{sb}	—	0,1	100	μ A
Switch-on current		I_{sw}	—	—	40	μ A
Input impedance		$ Z_i $	50	—	—	k Ω
Output power	THD = 0,5%; 4 Ω	P_O	—	5	—	W
	THD = 10%; 4 Ω	P_O	—	6	—	W
Channel separation		α	40	—	—	dB
Noise output voltage		$V_{no(rms)}$	—	150	—	μ V
Supply voltage ripple rejection	f = 100 Hz	SVRR	40	—	—	dB
	f = 1 kHz to 10 kHz	SVRR	48	—	—	dB
Crystal temperature		T_c	—	—	150	$^{\circ}$ C

PACKAGE OUTLINE

9-lead SIL-bent-to-DIL; plastic (SOT110B); SOT110-1; 1996 July 19.

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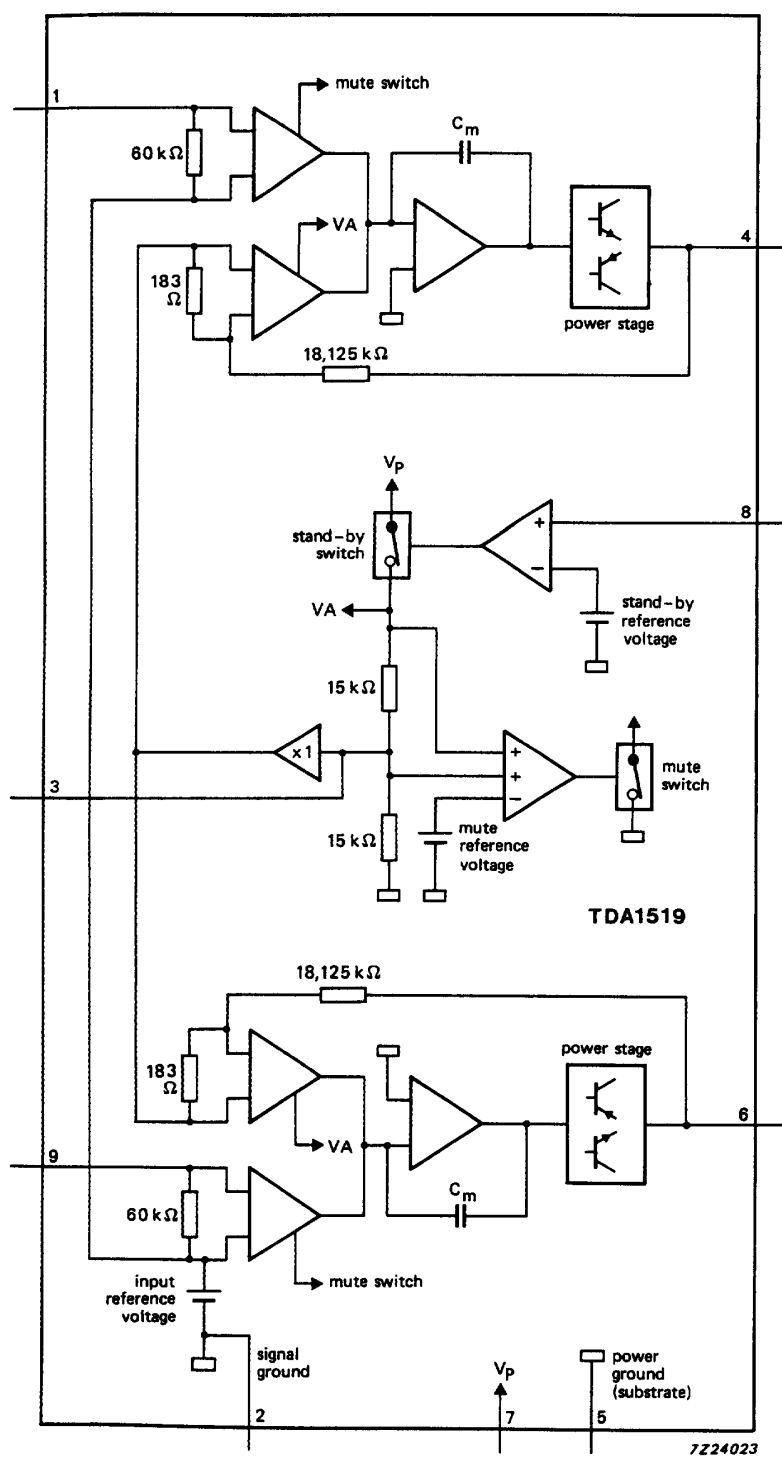


Fig.1 Block diagram.

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PINNING

1	INV1	non-inverting input 1
2	GND1	ground (signal)
3	SVRR	supply voltage ripple rejection
4	OUT1	output 1
5	GND2	ground (substrate)
6	OUT2	output 2
7	V _P	supply voltage
8	M/SS	mute/stand-by switch
9	–INV2	non-inverting input 2

FUNCTIONAL DESCRIPTION

The TDA1519 contains two identical amplifiers with differential input stages. The gain of each amplifier is fixed at 40 dB. A special feature of this device is the mute/stand-by switch which has the following features:

- low stand-by current (< 100 µA)
- low mute/stand-by switching current (low cost supply switch)
- mute condition.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

PARAMETER	CONDITIONS	SYMBOL	MIN.	MAX.	UNIT
Supply voltage					
operating		V _P	–	18	V
non-operating		V _P	–	30	V
load dump protected	during 50 ms; t _r ≥ 2,5 ms	V _P	–	45	V
AC and DC short-circuit-safe voltage		V _{PSC}	–	18	V
Reverse polarity		V _{PR}	–	6	V
Energy handling capability at outputs	V _P = 0 V		–	200	mJ
Non-repetitive peak output current		I _{OSM}	–	4	A
Repetitive peak output current		I _{ORM}	–	2,5	A
Total power dissipation	see Fig.2	P _{tot}	–	15	W
Crystal temperature		T _c	–	150	°C
Storage temperature range		T _{stg}	–55	+ 150	°C

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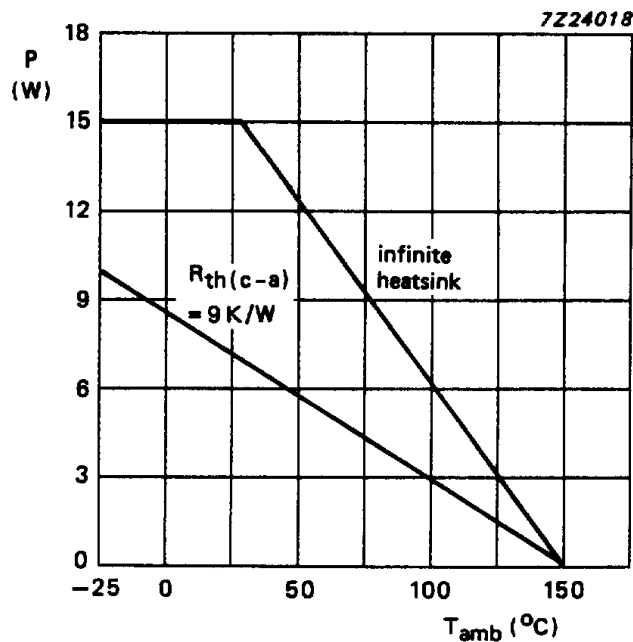


Fig.2 Power derating curve.

DC CHARACTERISTICS (note 1)

$V_P = 14,4\text{ V}$; $T_{amb} = 25\text{ }^{\circ}C$; unless otherwise specified

PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply						
Supply voltage range	note 2	V_P	6,0	14,4	18,0	V
Quiescent current		I_P	–	40	80	mA
DC output voltage	note 3	V_O	–	6,95	–	V
Mute/stand-by switch						
Switch-on voltage level	see Fig.3	V_{ON}	8,5	–	–	V
Mute condition						
Output signal in mute position	$V_I = 1\text{ V (max.)}$; $f = 20\text{ Hz to } 15\text{ kHz}$	V_{mute}	3,3	–	6,4	V
Stand-by condition						
		V_O	–	–	20	mV
		V_{sb}	0	–	2	V
DC current in stand-by condition		I_{sb}	–	–	100	μA
Switch-on current		I_{sw}	–	12	40	μA

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AC CHARACTERISTICS (note 1)

$V_P = 14,4 \text{ V}$; $R_L = 4 \Omega$; $f = 1 \text{ kHz}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; unless otherwise specified

PARAMETER	CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Output power	note 4;					
	THD = 0,5%	P_O	4	5	—	W
	THD = 10%	P_O	5,5	6,0	—	W
Total harmonic distortion	$P_O = 1 \text{ W}$	THD	—	0,1	—	%
Low frequency roll-off	note 5;					
	−3 dB	f_L	—	45	—	Hz
High frequency roll-off	−1 dB	f_H	20	—	—	kHz
Closed loop voltage gain		G_V	39	40	41	dB
Supply voltage ripple rejection	note 6					
ON	$f = 100 \text{ Hz}$	SVRR	40	—	—	dB
ON	$f = 10 \text{ Hz to } 10 \text{ kHz}$	SVRR	48	—	—	dB
mute		SVRR	48	—	—	dB
stand-by		SVRR	80	—	—	dB
Input impedance		$ Z_i $	50	60	75	k Ω
Noise output voltage	note 7;					
ON	$R_S = 0 \Omega$	$V_{\text{no(rms)}}$	—	150	—	μV
ON	$R_S = 10 \text{ k}\Omega$	$V_{\text{no(rms)}}$	—	250	500	μV
mute	note 8	$V_{\text{no(rms)}}$	—	120	—	μV
Channel separation	$R_S = 10 \text{ k}\Omega$	α	40	—	—	dB
Channel balance		$ \Delta G_V $	—	0,1	1	dB

Notes to the characteristics

1. All characteristics are measured using the circuit shown in Fig.4.
2. The circuit is DC adjusted at $V_P = 6 \text{ V to } 18 \text{ V}$ and AC operating at $V_P = 8,5 \text{ V to } 18 \text{ V}$.
3. At $18 \text{ V} < V_P < 30 \text{ V}$ the DC output voltage $\leq V_P/2$.
4. Output power is measured directly at the output pins of the IC.
5. Frequency response externally fixed.
6. Ripple rejection measured at the output with a source impedance of 0Ω (maximum ripple amplitude of 2 V) and a frequency between 100 Hz and 10 kHz .
7. Noise voltage measured in a bandwidth of $20 \text{ Hz to } 20 \text{ kHz}$.
8. Noise output voltage independent of R_S ($V_I = 0 \text{ V}$).

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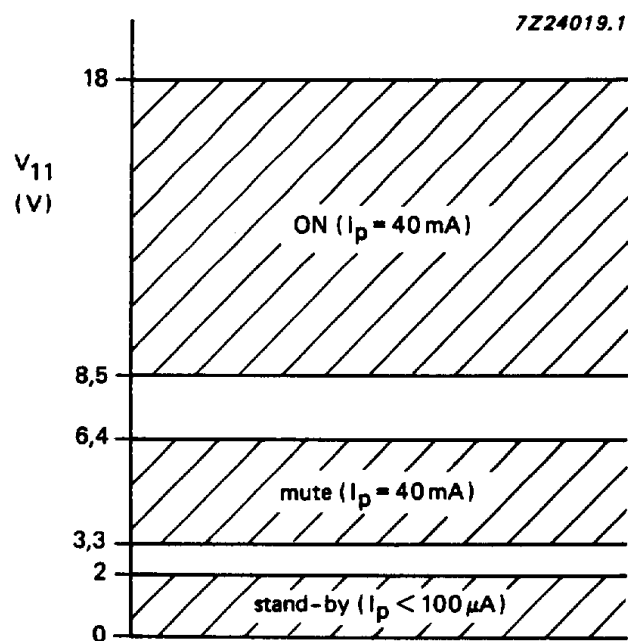


Fig.3 Stand-by, mute and ON conditions.

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APPLICATION INFORMATION

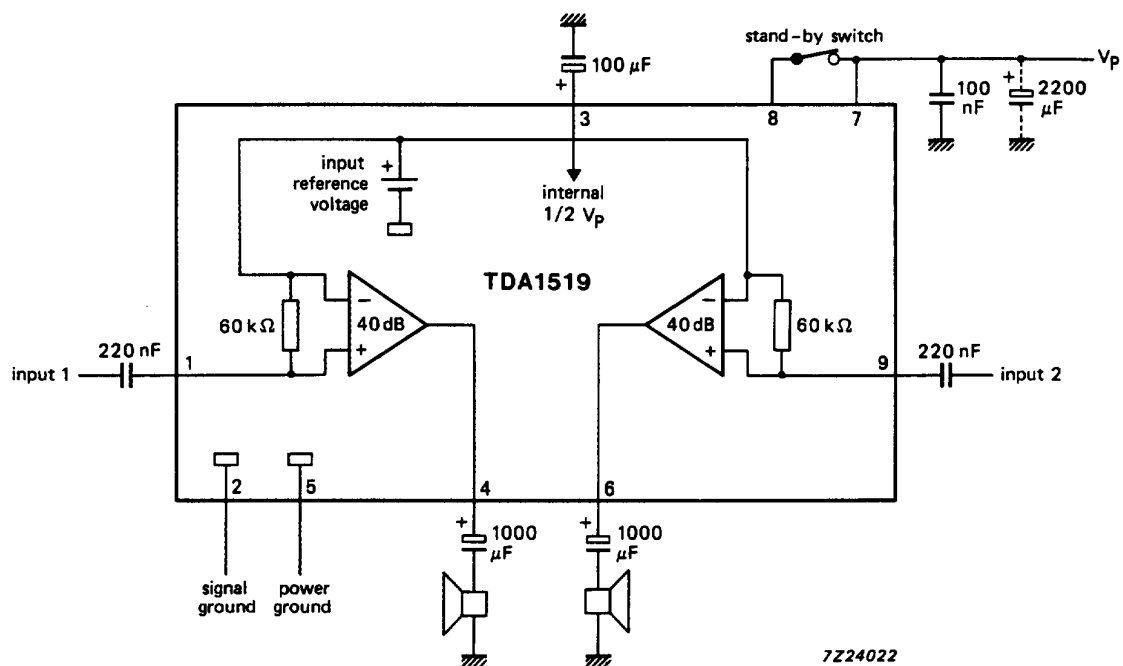


Fig.4 Application circuit diagram.

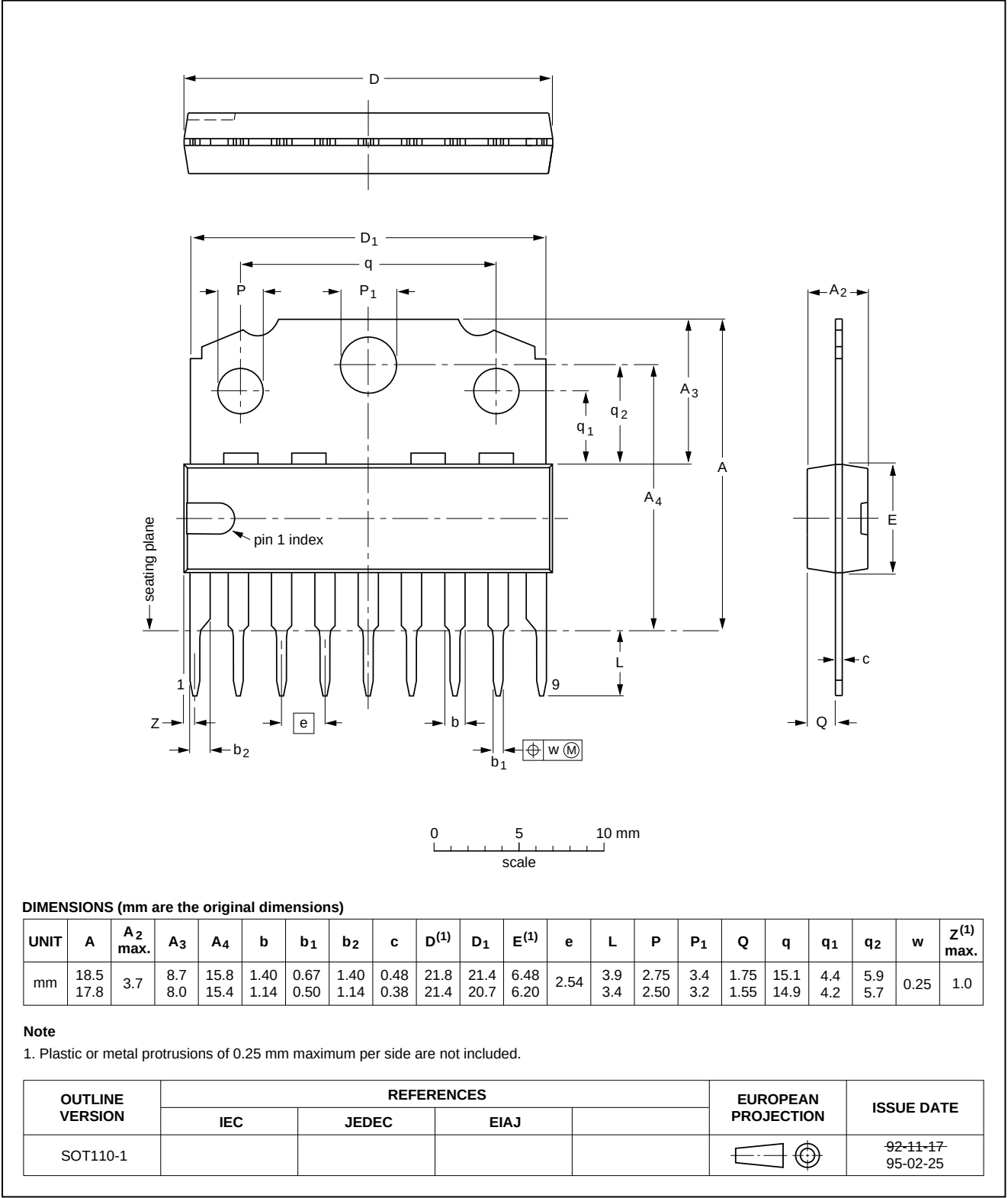
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PACKAGE OUTLINE

SIL9MPF: plastic single in-line medium power package with fin; 9 leads

SOT110-1



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SOLDERING**Introduction**

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg\ max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

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